

# Spread Spectrum Clock Generator

## MB88152A

### MB88152A-100/101/102/110/111/112

#### ■ DESCRIPTION

MB88152A is a clock generator for EMI (Electro Magnetic Interference) reduction. The peak of unnecessary radiation noise (EMI) can be attenuated by making the oscillation frequency slightly modulate periodically with the internal modulator. It corresponds to both of the center spread which modulates input frequency as Middle Centered and down spread which modulates so as not to exceed input frequency.

#### ■ FEATURES

- Input frequency : 16.6 MHz to 134 MHz
- Output frequency : 16.6 MHz to 134 MHz
- Modulation rate :  $\pm 0.5\%$ ,  $\pm 1.5\%$  (Center spread),  $- 1.0\%$ ,  $- 3.0\%$  (Down spread)
- Equipped with oscillation circuit: Range of oscillation 16.6 MHz to 48 MHz
- Modulation clock output Duty : 40% to 60%
- Modulation clock Cycle-Cycle Jitter : Less than 100 ps
- Low current consumption by CMOS process : 5 mA (24 MHz : Typ-sample, no load)
- Power supply voltage : 3.3 V  $\pm$  0.3 V
- Operating temperature :  $- 40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$
- Package : SOP 8-pin

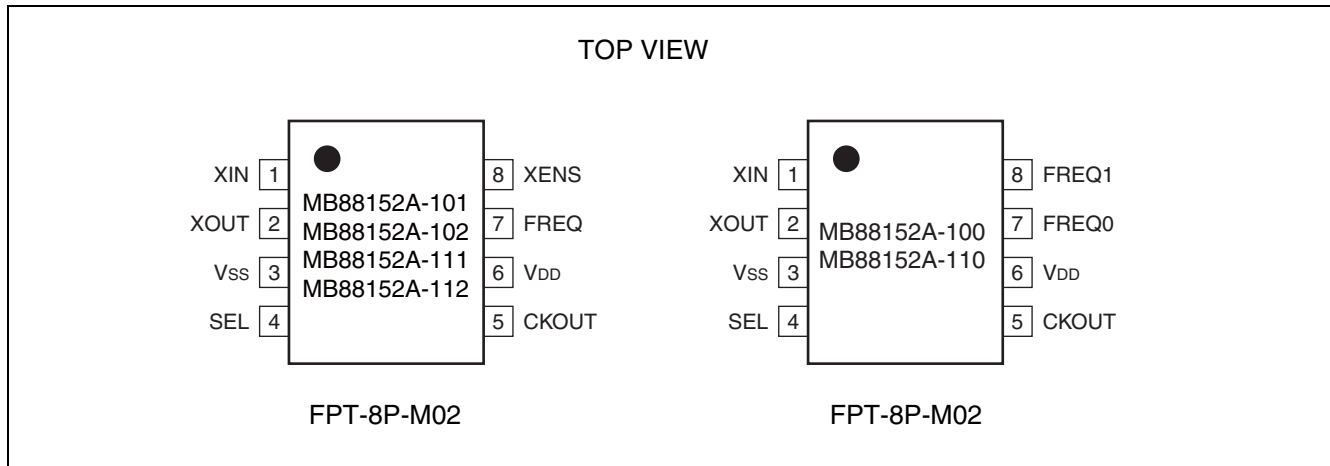
# MB88152A

## ■ PRODUCT LINE-UP

MB88152A has three kinds of input frequency, and two kinds of modulation type (center/down spread), total six line-ups.

| Product      | Input/Output Frequency | Modulation type | Modulation enable pin |
|--------------|------------------------|-----------------|-----------------------|
| MB88152A-100 | 16.6 MHz to 134 MHz    | Down spread     | No                    |
| MB88152A-101 | 16.6 MHz to 67 MHz     |                 | Yes                   |
| MB88152A-102 | 40 MHz to 134 MHz      |                 |                       |
| MB88152A-110 | 16.6 MHz to 134 MHz    | Center spread   | No                    |
| MB88152A-111 | 16.6 MHz to 67 MHz     |                 | Yes                   |
| MB88152A-112 | 40 MHz to 134 MHz      |                 |                       |

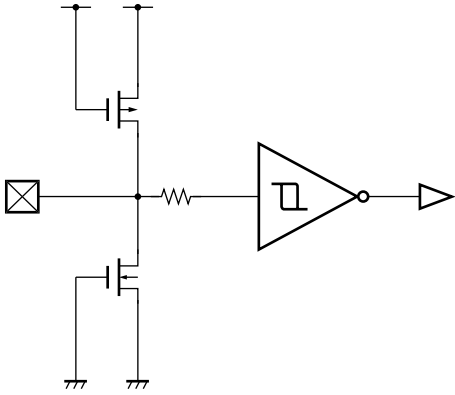
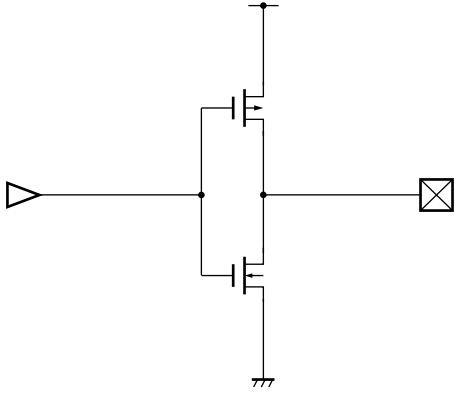
## ■ PIN ASSIGNMENT



## ■ PIN DESCRIPTION

| Pin name        | I/O | Pin no. | Description   |
|-----------------|-----|---------|---|
| XIN             | I   | 1       | Crystal resonator connection pin/clock input pin    |
| XOUT            | O   | 2       | Crystal resonator connection pin                    |
| V <sub>SS</sub> | —   | 3       | GND pin   |
| SEL             | I   | 4       | Modulation rate setting pin                         |
| CKOUT           | O   | 5       | Modulated clock output pin                          |
| V <sub>DD</sub> | —   | 6       | Power supply voltage pin                            |
| FREQ/FREQ0      | I   | 7       | Frequency setting pin                               |
| XENS/FREQ1      | I   | 8       | Modulation enable setting pin/frequency setting pin |

## ■ I/O CIRCUIT TYPE

| Pin                                   | Circuit type   | Remarks   |
|---------------------------------------|--|---|
| SEL<br>FREQ<br>FREQ0<br>FREQ1<br>XENS |   | CMOS hysteresis input   |
| CKOUT                                 |  | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• <math>I_{OL} = 4 \text{ mA}</math></li> </ul> |

Note : For XIN and XOUT pins, refer to “■ OSCILLATION CIRCUIT”.

## ■ HANDLING DEVICES

### Preventing Latch-up

A latch-up can occur if, on this device, (a) a voltage higher than  $V_{DD}$  or a voltage lower than  $V_{SS}$  is applied to an input or output pin or (b) a voltage higher than the rating is applied between  $V_{DD}$  and  $V_{SS}$ . The latch-up, if it occurs, significantly increases the power supply current and may cause thermal destruction of an element. When you use this device, be very careful not to exceed the maximum rating.

### Handling unused pins

Do not leave an unused input pin open, since it may cause a malfunction. Handle by, using a pull-up or pull-down resistor.

Unused output pin should be opened.

### The attention when the external clock is used

Input the clock to XIN pin, and XOUT pin should be opened when you use the external clock.

Please pay attention so that an overshoot and an undershoot do not occur to an input clock of XIN pin.

### Power supply pins

Please design connecting the power supply pin of this device by as low impedance as possible from the current supply source.

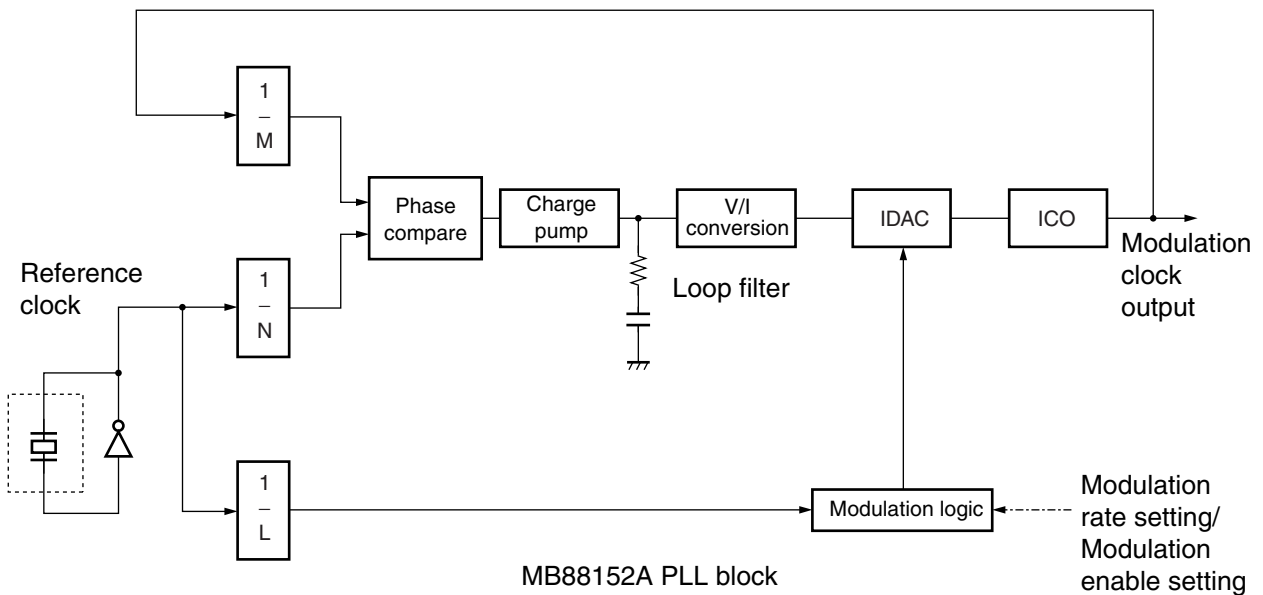
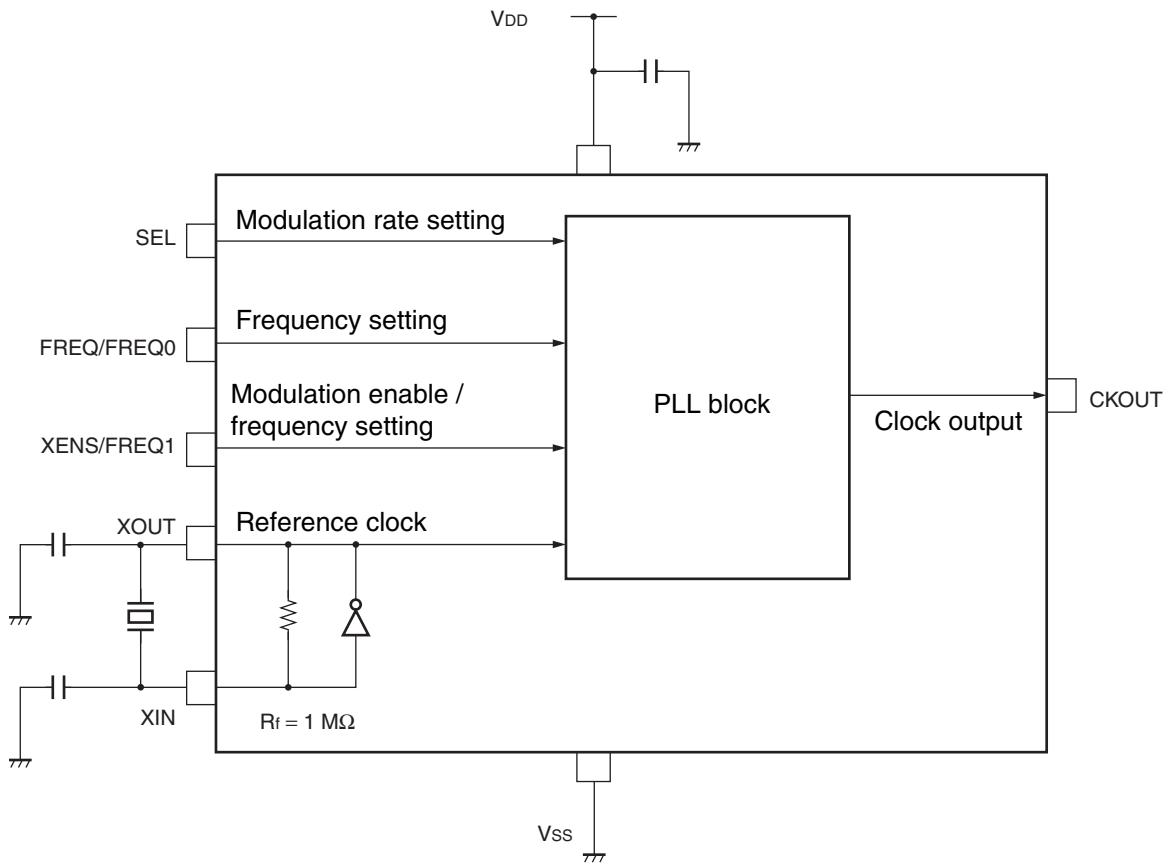
We recommend connecting electrolytic capacitor (about 10  $\mu\text{F}$ ) and the ceramic capacitor (about 0.01  $\mu\text{F}$ ) in parallel between  $V_{SS}$  and  $V_{DD}$  near the device, as a bypass capacitor.

### Oscillation Circuit

Noise near the XIN and XOUT pins may cause the device to malfunction. Design printed circuit boards so that electric wiring of XIN or XOUT pin and resonator (or ceramic oscillator) do not intersect other wiring.

Design the printed circuit board that surrounds the XIN and XOUT pins with ground.

## ■ BLOCK DIAGRAM



A glitchless IDAC (current output D/A converter) provides precise modulation, thereby dramatically reducing EMI.

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## ■ PIN SETTING

When changing the pin setting, the stabilization wait time for the modulation clock is required. The stabilization wait time for the modulation clock takes the maximum value of Lock-Up time in “■ ELECTRICAL CHARACTERISTICS • AC characteristics Lock-Up time”.

### Modulation enable setting

| XENS | Modulation    |                             |
|------|---------------|-----------------------------|
| L    | Modulation    | MB88152A-101, 102, 111, 112 |
| H    | No modulation |                             |

Note : MB88152A-100 and 110 do not have XENS pin.

### SEL modulation rate setting

| SEL | Modulation rate |                        | Remarks       |
|-----|-----------------|------------------------|---------------|
| L   | ± 0.5%          | MB88152A-110, 111, 112 | Center spread |
|     | – 1.0%          | MB88152A-100, 101, 102 | Down spread   |
| H   | ± 1.5%          | MB88152A-110, 111, 112 | Center spread |
|     | – 3.0%          | MB88152A-100, 101, 102 | Down spread   |

Note : The modulation rate can be changed at the level of the terminal.

### Frequency setting

| FREQ | Frequency          |                   |
|------|--------------------|-------------------|
| L    | 16.6 MHz to 40 MHz | MB88152A-101, 111 |
|      | 40 MHz to 80 MHz   | MB88152A-102, 112 |
| H    | 33 MHz to 67 MHz   | MB88152A-101, 111 |
|      | 66 MHz to 134 MHz  | MB88152A-102, 112 |

Note : MB88152A-100 and 110 do not have FREQ pin.

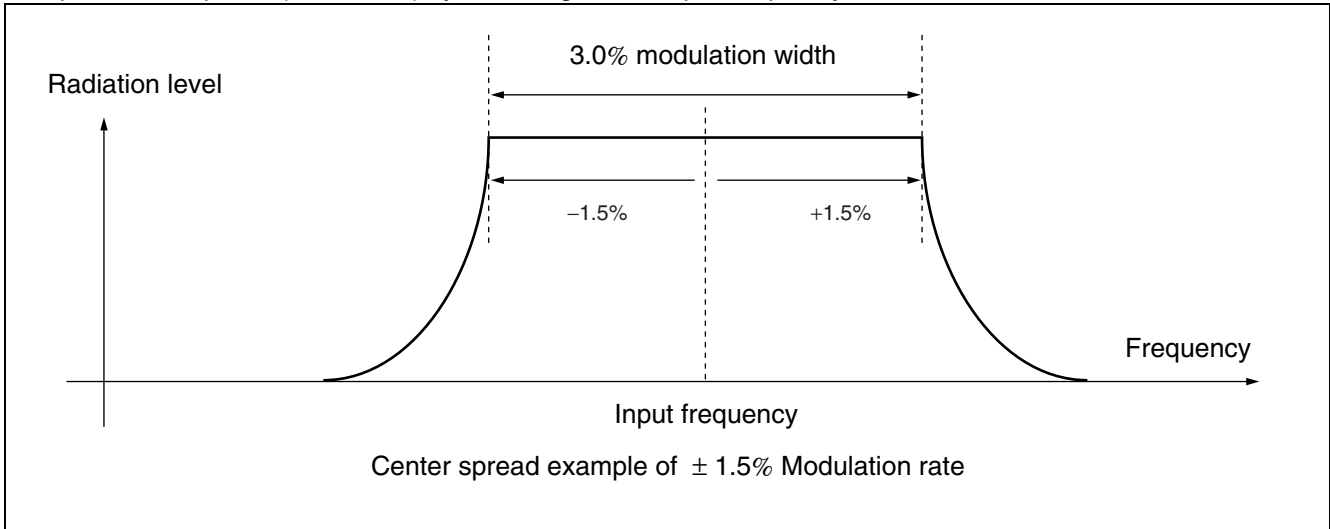
### Frequency setting

| FREQ1 | FREQ0 | Frequency          |                   |
|-------|-------|--------------------|-------------------|
| L     | L     | 16.6 MHz to 40 MHz | MB88152A-100, 110 |
| L     | H     | 33 MHz to 67 MHz   |                   |
| H     | L     | 40 MHz to 80 MHz   |                   |
| H     | H     | 66 MHz to 134 MHz  |                   |

Note : MB88152A-101, 111, 102 and 112 have neither FREQ0 pin nor FREQ1 pin.

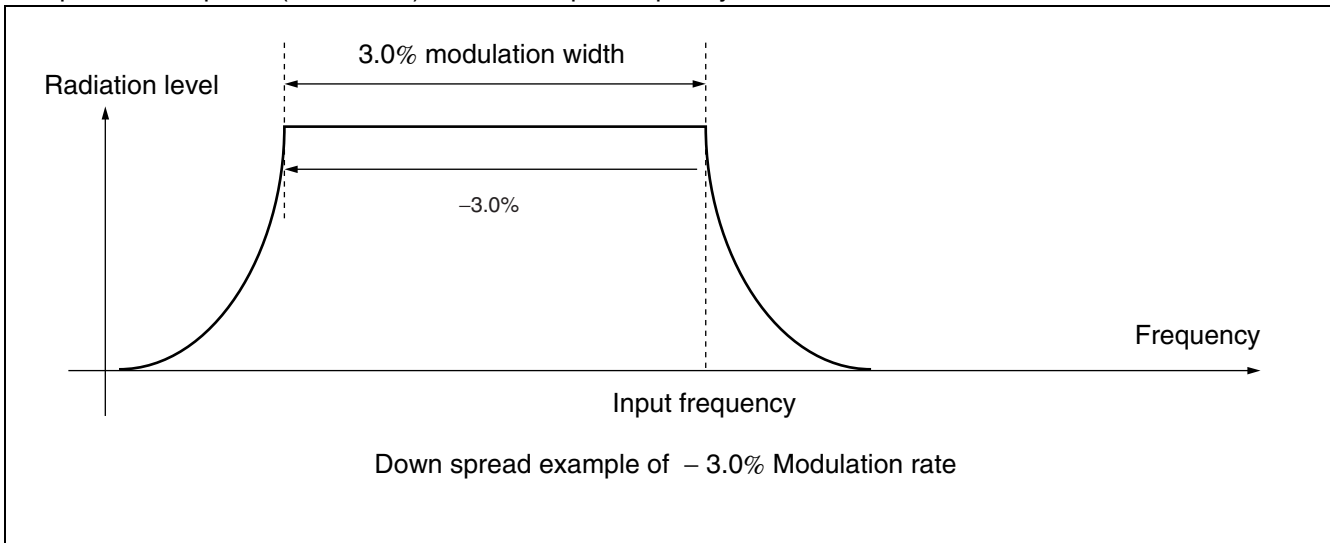
- Center spread

Spectrum is spread (modulated) by centering on the input frequency.



- Down spread

Spectrum is spread (modulated) below the input frequency.

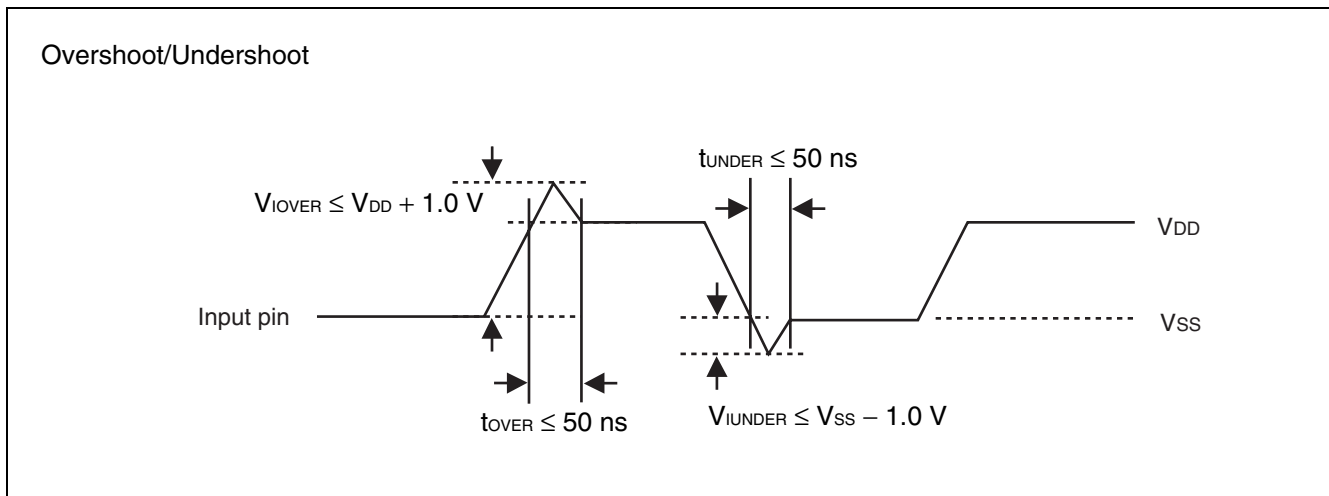


## ■ ABSOLUTE MAXIMUM RATINGS

| Parameter                      | Symbol       | Rating                                   |   | Unit |
|--------------------------------|--------------|--|---|------|
|                                |              | Min                                      | Max                                     |      |
| Power supply voltage*          | $V_{DD}$     | - 0.5                                    | + 4.0                                   | V    |
| Input voltage*                 | $V_I$        | $V_{SS} - 0.5$                           | $V_{DD} + 0.5$                          | V    |
| Output voltage*                | $V_O$        | $V_{SS} - 0.5$                           | $V_{DD} + 0.5$                          | V    |
| Storage temperature            | $T_{ST}$     | - 55                                     | + 125                                   | °C   |
| Operation junction temperature | $T_J$        | - 40                                     | + 125                                   | °C   |
| Output current                 | $I_O$        | - 14                                     | + 14                                    | mA   |
| Overshoot                      | $V_{IOVER}$  | —  | $V_{DD} + 1.0$ ( $t_{OVER} \leq 50$ ns) | V    |
| Undershoot                     | $V_{IUNDER}$ | $V_{SS} - 1.0$ ( $t_{UNDER} \leq 50$ ns) | —                                       | V    |

\* : The parameter is based on  $V_{SS} = 0.0$  V.

**WARNING:** Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.





## RECOMMENDED OPERATING CONDITIONS

( $V_{SS} = 0.0\text{ V}$ )

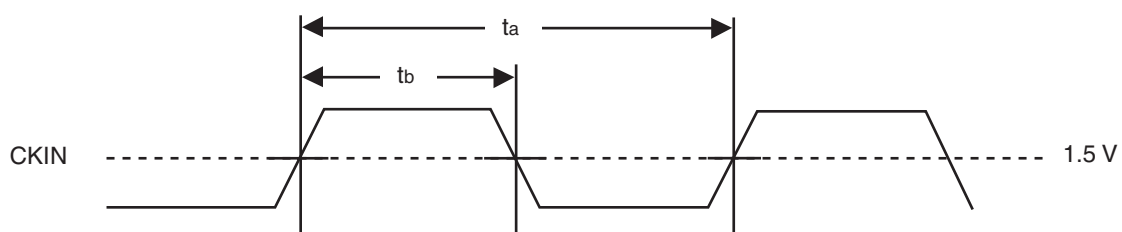
| Parameter               | Symbol    | Pin                               | Conditions  | Value               |     |                     | Unit |
|-------------------------|-----------|-----------------------------------|---|---------------------|-----|---------------------|------|
|                         |           |                                   |   | Min                 | Typ | Max                 |      |
| Power supply voltage    | $V_{DD}$  | $V_{DD}$                          | —   | 3.0                 | 3.3 | 3.6                 | V    |
| “H” level input voltage | $V_{IH}$  | SEL,<br>FREQ/FREQ0,<br>XENS/FREQ1 | —   | $V_{DD} \times 0.8$ | —   | $V_{DD} + 0.3$      | V    |
|                         |           | XIN                               | Input through rate<br>3 V / ns<br>16.6 MHz to 100 MHz | $V_{DD} \times 0.8$ | —   | $V_{DD} + 0.3$      | V    |
|                         |           |                                   | Input through rate<br>3 V / ns<br>100 MHz to 134 MHz  | $V_{DD} \times 0.9$ | —   | $V_{DD} + 0.3$      | V    |
| “L” level input voltage | $V_{IL}$  | SEL,<br>FREQ/FREQ0,<br>XENS/FREQ1 | —   | $V_{SS}$            | —   | $V_{DD} \times 0.2$ | V    |
|                         |           | XIN                               | Input through rate<br>3 V / ns<br>16.6 MHz to 100 MHz | $V_{SS}$            | —   | $V_{DD} + 0.2$      | V    |
|                         |           |                                   | Input through rate<br>3 V / ns<br>100 MHz to 134 MHz  | $V_{SS}$            | —   | $V_{DD} + 0.1$      | V    |
| Input clock duty cycle  | $t_{DCI}$ | XIN                               | 16.6 MHz to 100 MHz                                   | 40                  | 50  | 60                  | %    |
|                         |           |                                   | 100 MHz to 134 MHz                                    | 45                  | 50  | 55                  |      |
| Operating temperature   | $T_a$     | —                                 | —   | -40                 | —   | + 85                | °C   |

**WARNING:** The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device’s electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

Input clock duty cycle ( $t_{DCI} = t_b/t_a$ )



# MB88152A

## ■ ELECTRICAL CHARACTERISTICS

- DC Characteristics

( $T_a = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ ,  $V_{DD} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = 0.0\text{ V}$ )

| Parameter            | Symbol   | Pin   | Conditions   | Value          |     |          | Unit     |
|----------------------|----------|---|--|----------------|-----|----------|----------|
|                      |          |   |  | Min            | Typ | Max      |          |
| Power supply current | $I_{CC}$ | $V_{DD}$  | 24 MHz output<br>No load capacitance   | —              | 5.0 | 7.0      | mA       |
| Output voltage       | $V_{OH}$ | CKOUT   | “H” level output<br>$I_{OH} = -4\text{ mA}$  | $V_{DD} - 0.5$ | —   | $V_{DD}$ | V        |
|                      | $V_{OL}$ |   | “L” level output<br>$I_{OL} = 4\text{ mA}$   | $V_{SS}$       | —   | 0.4      | V        |
| Output impedance     | $Z_o$    | CKOUT   | 16.6 MHz to 134 MHz  | —              | 45  | —        | $\Omega$ |
| Input capacitance    | $C_{IN}$ | XIN,<br>SEL,<br>FREQ/<br>FREQ0,<br>XENS/<br>FREQ1 | $T_a = +25\text{ }^{\circ}\text{C}$<br>$V_{DD} = V_I = 0.0\text{ V}$<br>$f = 1\text{ MHz}$ | —              | —   | 16       | pF       |
| Load capacitance     | $C_L$    | CKOUT   | 16.6 MHz to 67 MHz   | —              | —   | 15       | pF       |
|                      |          |   | 67 MHz to 100 MHz  | —              | —   | 10       |          |
|                      |          |   | 100 MHz to 134 MHz   | —              | —   | 7        |          |

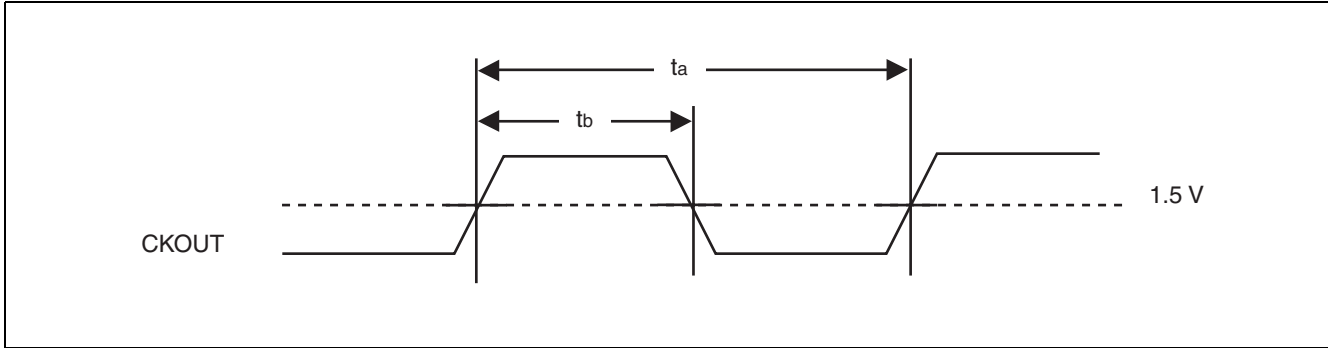
- AC Characteristics

( $T_a = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ ,  $V_{DD} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = 0.0\text{ V}$ )

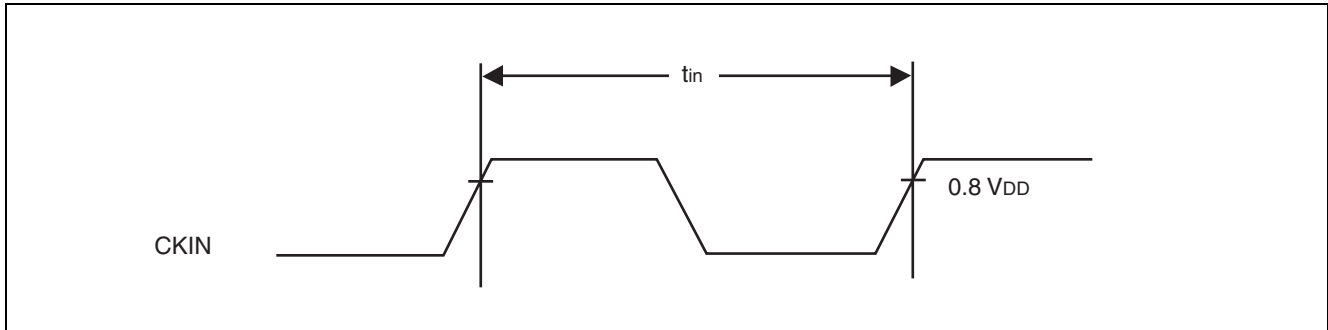
| Parameter               | Symbol    | Pin          | Conditions  | Value |      |     | Unit |
|-------------------------|-----------|--------------|---|-------|------|-----|------|
|                         |           |              |   | Min   | Typ  | Max |      |
| Oscillation frequency   | $f_x$     | XIN,<br>XOUT | Fundamental oscillation   | 16.6  | —    | 40  | MHz  |
|                         |           |              | 3rd over tone   | 40    | —    | 48  |      |
| Input frequency         | $f_{in}$  | XIN          | MB88152A-100, 110   | 16.6  | —    | 134 | MHz  |
|                         |           |              | MB88152A-101, 111   | 16.6  | —    | 67  |      |
|                         |           |              | MB88152A-102, 112   | 40    | —    | 134 |      |
| Output frequency        | $f_{OUT}$ | CKOUT        | MB88152A-100, 110   | 16.6  | —    | 134 | MHz  |
|                         |           |              | MB88152A-101, 111   | 16.6  | —    | 67  |      |
|                         |           |              | MB88152A-102, 112   | 40    | —    | 134 |      |
| Output slew rate        | SR        | CKOUT        | 0.4 V to 2.4 V<br>Load capacitance 15 pF  | 0.4   | —    | 4.0 | V/ns |
| Output clock duty cycle | $t_{DCC}$ | CKOUT        | 1.5 V   | 40    | —    | 60  | %    |
| Modulation cycle        | $f_{MOD}$ | CKOUT        | —   | —     | 12.5 | —   | kHz  |
| Lock-Up time            | $t_{LK}$  | CKOUT        | —   | —     | 2    | 5   | ms   |
| Cycle-cycle jitter      | $t_{JC}$  | CKOUT        | No load capacitance,<br>$T_a = +25\text{ }^\circ\text{C}$ ,<br>$V_{DD} = 3.3\text{ V}$ ,<br>Standard deviation $\sigma$ | —     | —    | 100 | ps   |

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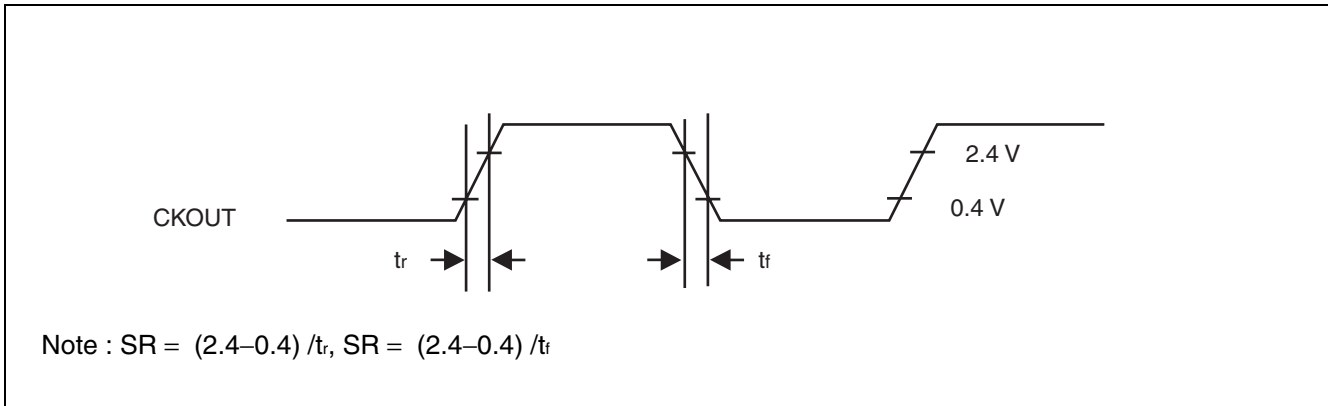
## ■ OUTPUT CLOCK DUTY CYCLE ( $t_{DCC} = t_b/t_a$ )



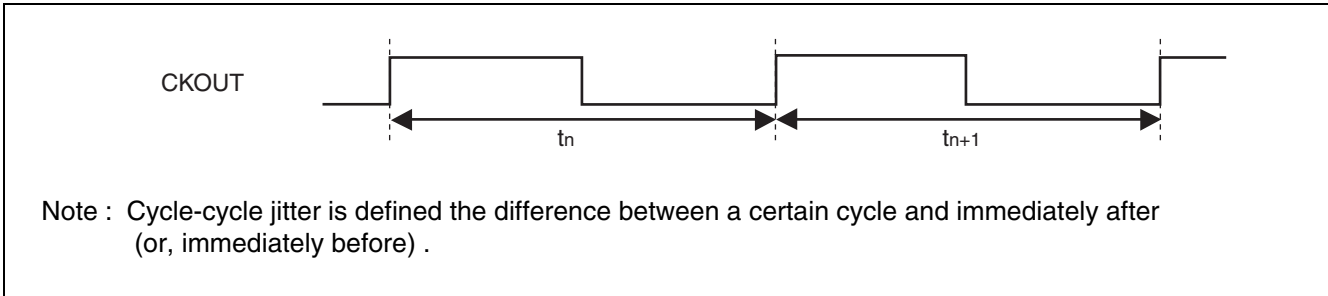
## ■ INPUT FREQUENCY ( $f_{in} = 1/t_{in}$ )



## ■ OUTPUT SLEW RATE (SR)

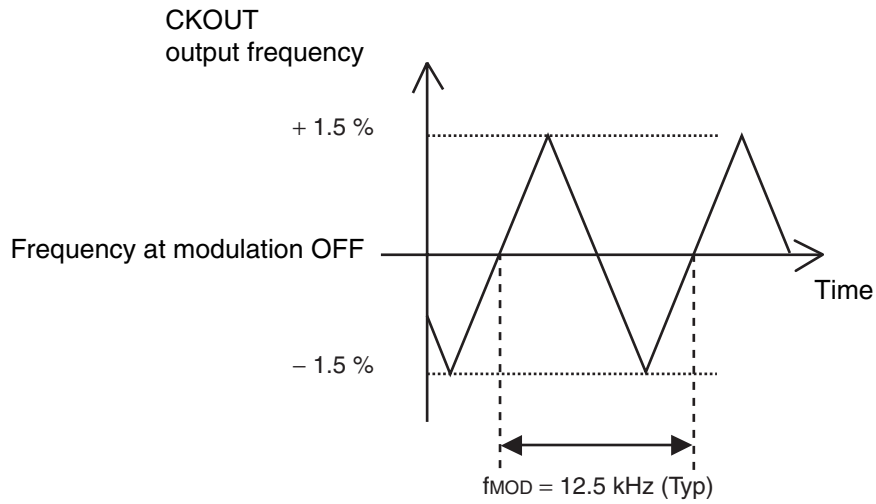


## ■ CYCLE-CYCLE JITTER ( $t_{JC} = |t_n - t_{n+1}|$ )

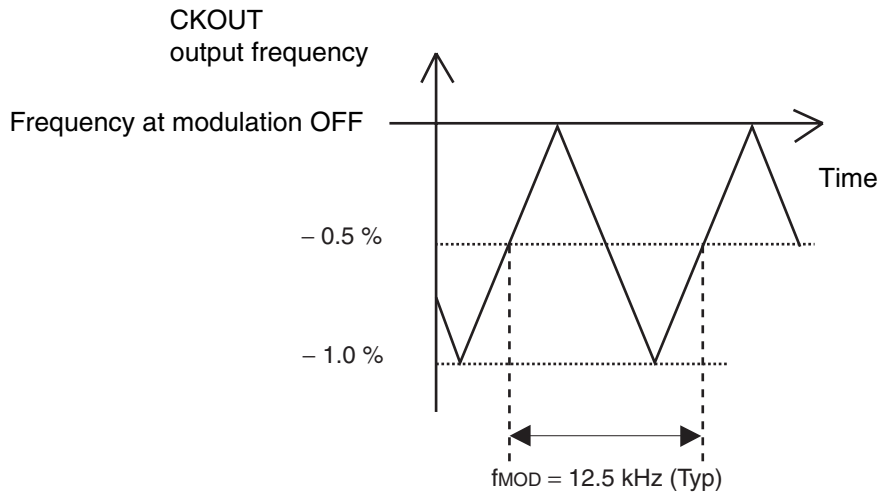


## ■ MODULATION WAVEFORM

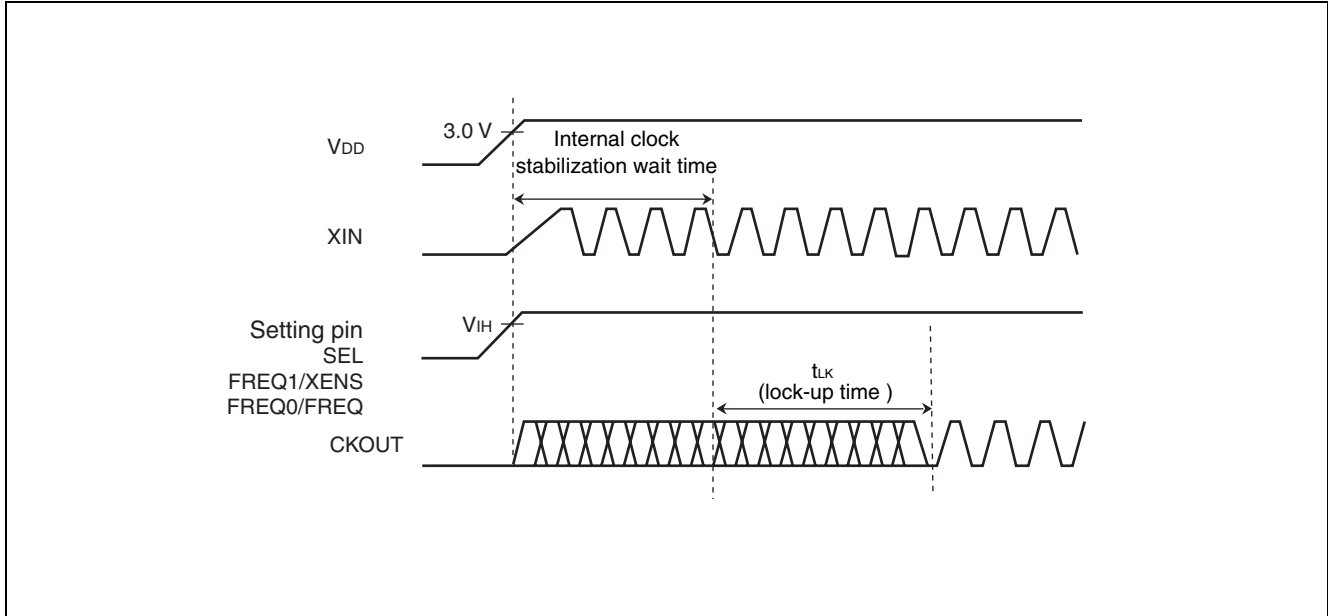
- $\pm 1.5\%$  modulation rate, Example of center spread



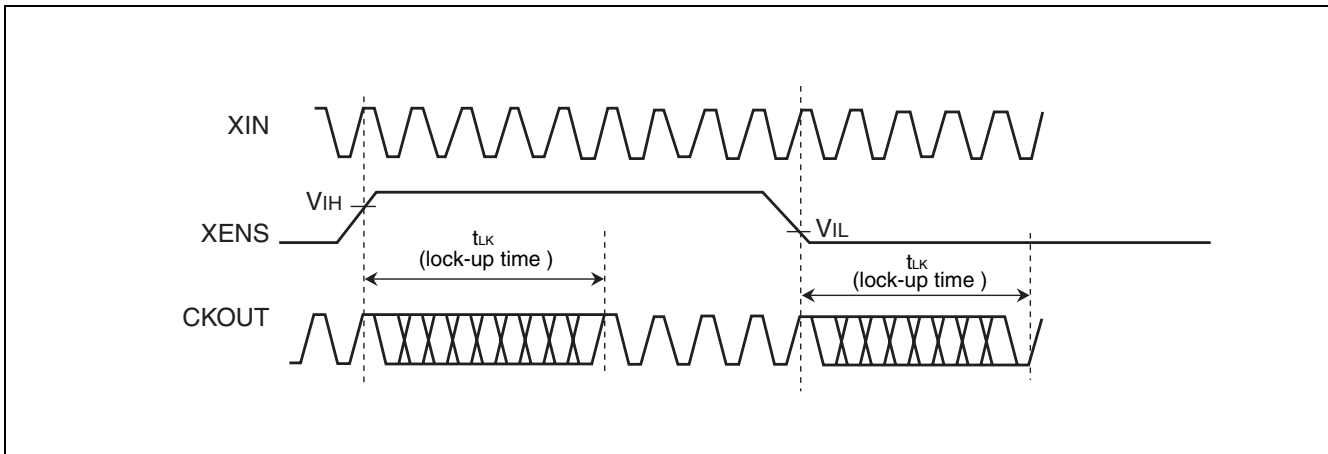
- $-1.0\%$  modulation rate, Example of down spread



## ■ LOCK-UP TIME



If the setting pin is fixed at the “H” or “L” level, the maximum time after the power is turned on until the set clock signal is output from CKOUT pin is (the stabilization wait time of input clock to XIN pin) + (the lock-up time “t<sub>LK</sub>”). For the input clock stabilization time, check the characteristics of the resonator or oscillator used.



For modulation enable control using the XENS pin during normal operation, the set clock signal is output from CKOUT pin at most the lock-up time (t<sub>LK</sub>) after the level at the XENS pin is determined.

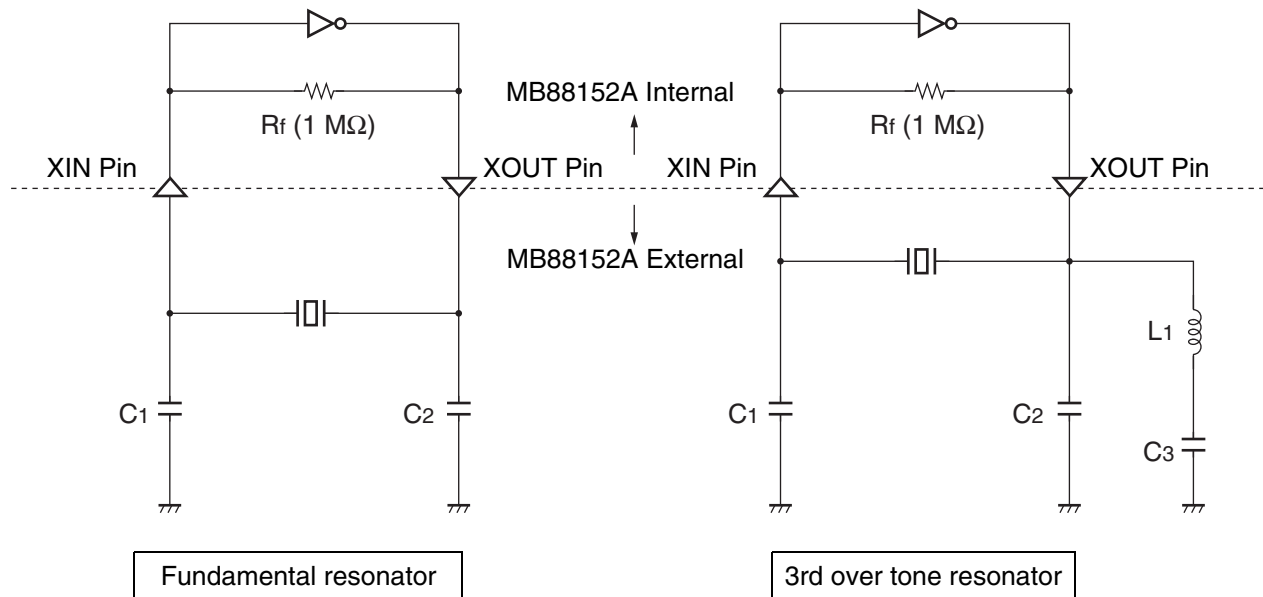
Note : When the pin setting is changed, the CKOUT pin output clock stabilization time is required. Until the output clock signal becomes stable, the output frequency, output clock duty cycle, modulation period, and cycle-cycle jitter cannot be guaranteed. It is therefore advisable to perform processing such as cancelling a reset of the device at the succeeding stage after the lock-up time.

## ■ OSCILLATION CIRCUIT

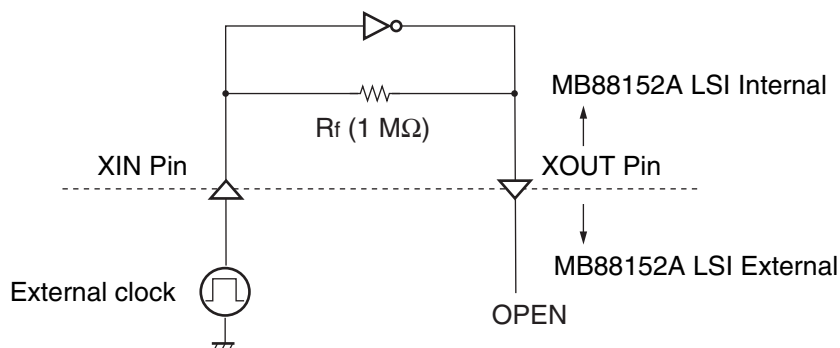
The left side of figures below shows the connection example about general resonator. The oscillation circuit has the built-in feedback resistance ( $1\text{ M}\Omega$ ). The value of capacity ( $C_1$  and  $C_2$ ) is required adjusting to the most suitable value of an individual resonator.

The right side of figures below shows the example of connecting for the 3rd over-tone resonator. The value of capacity ( $C_1$ ,  $C_2$  and  $C_3$ ) and inductance ( $L_1$ ) is needed adjusting to the most suitable value of an individual resonator. The most suitable value is different by individual resonator. Please refer to the resonator manufacturer which you use for the most suitable value. When an external clock is used (the resonator is not used), input the clock to XIN pin and do not connect anything with XOUT pin.

### • When using the resonator



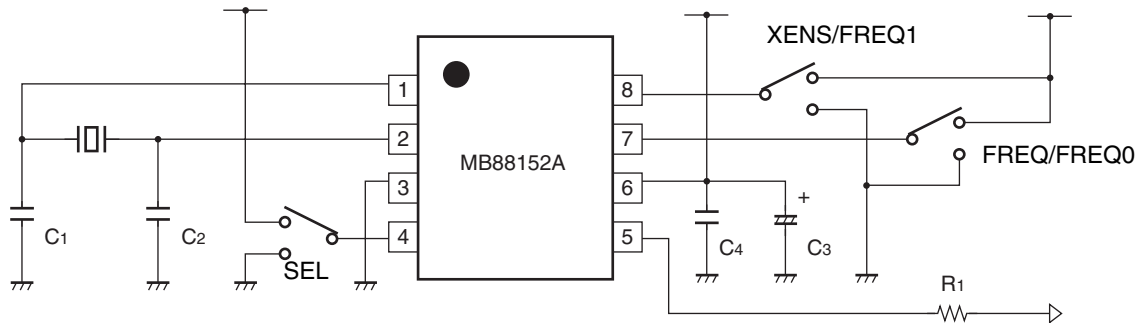
### • When using an external clock



Note : Note that a jitter characteristic of an input clock may cause an affect a cycle-cycle jitter characteristic.

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## ■ INTERCONNECTION CIRCUIT EXAMPLE



- C<sub>1</sub>, C<sub>2</sub> : Oscillation stabilization capacitance (refer to "■ OSCILLATION CIRCUIT".)  
C<sub>3</sub> : Capacitor of 10 μF or higher  
C<sub>4</sub> : Capacitor about 0.01 μF (connect a capacitor of good high frequency property (ex. laminated ceramic capacitor) to close to this device.)  
R<sub>1</sub> : Impedance matching resistor for board pattern

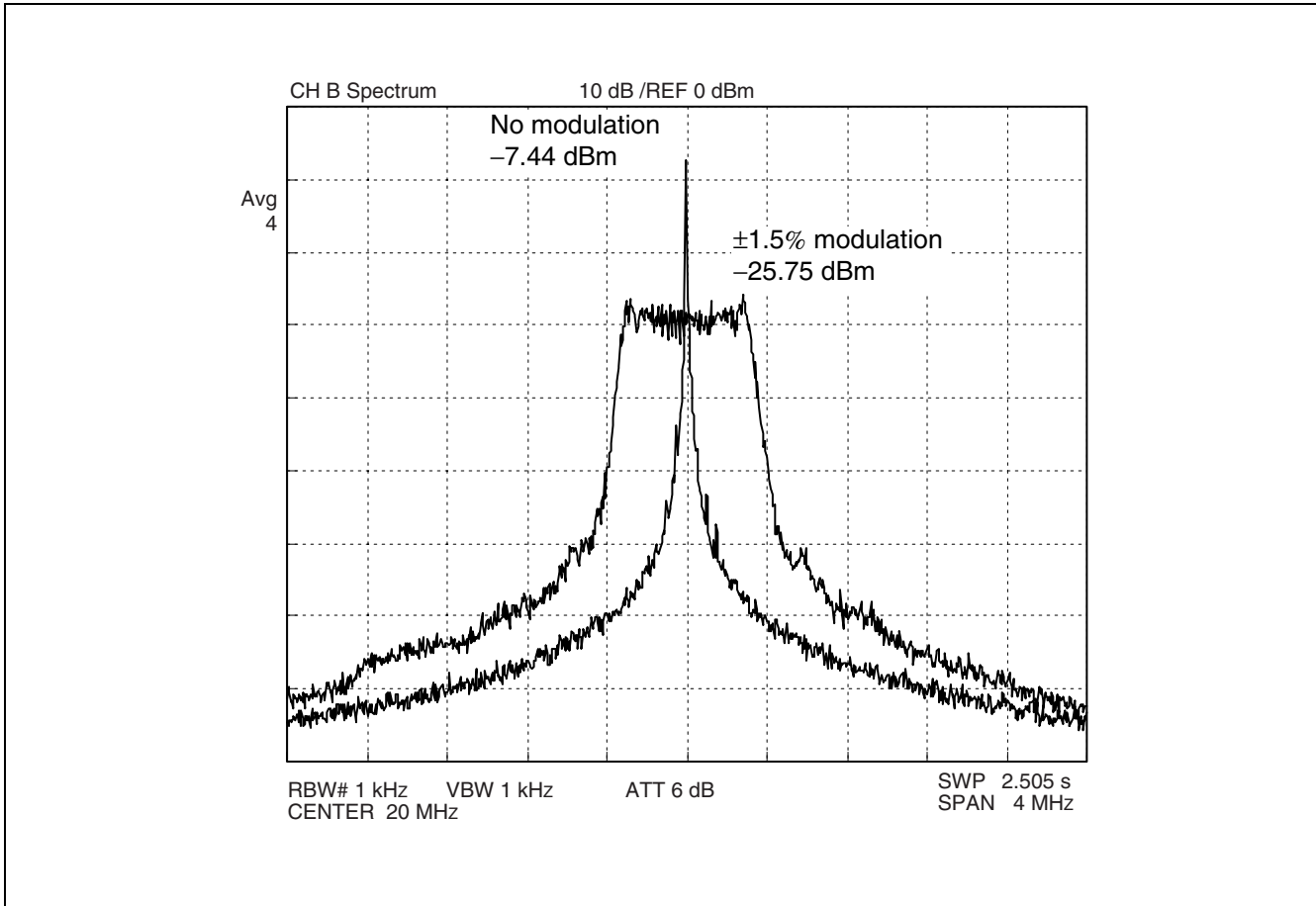


## ■ EXAMPLE CHARACTERISTICS

The condition of the examples of the characteristics is shown as follows : Input frequency = 20 MHz (Output frequency = 20 MHz : Use for MB88152A-111)

Power-supply voltage = 3.3 V, None load capacity, Modulation rate =  $\pm 1.5\%$  (center spread) .

Spectrum analyzer HP4396B is connected with CKOUT. The result of the measurement with, RBW = 1 kHz (ATT use for -6 dB) .

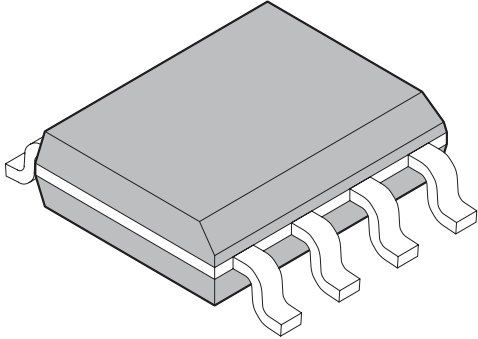


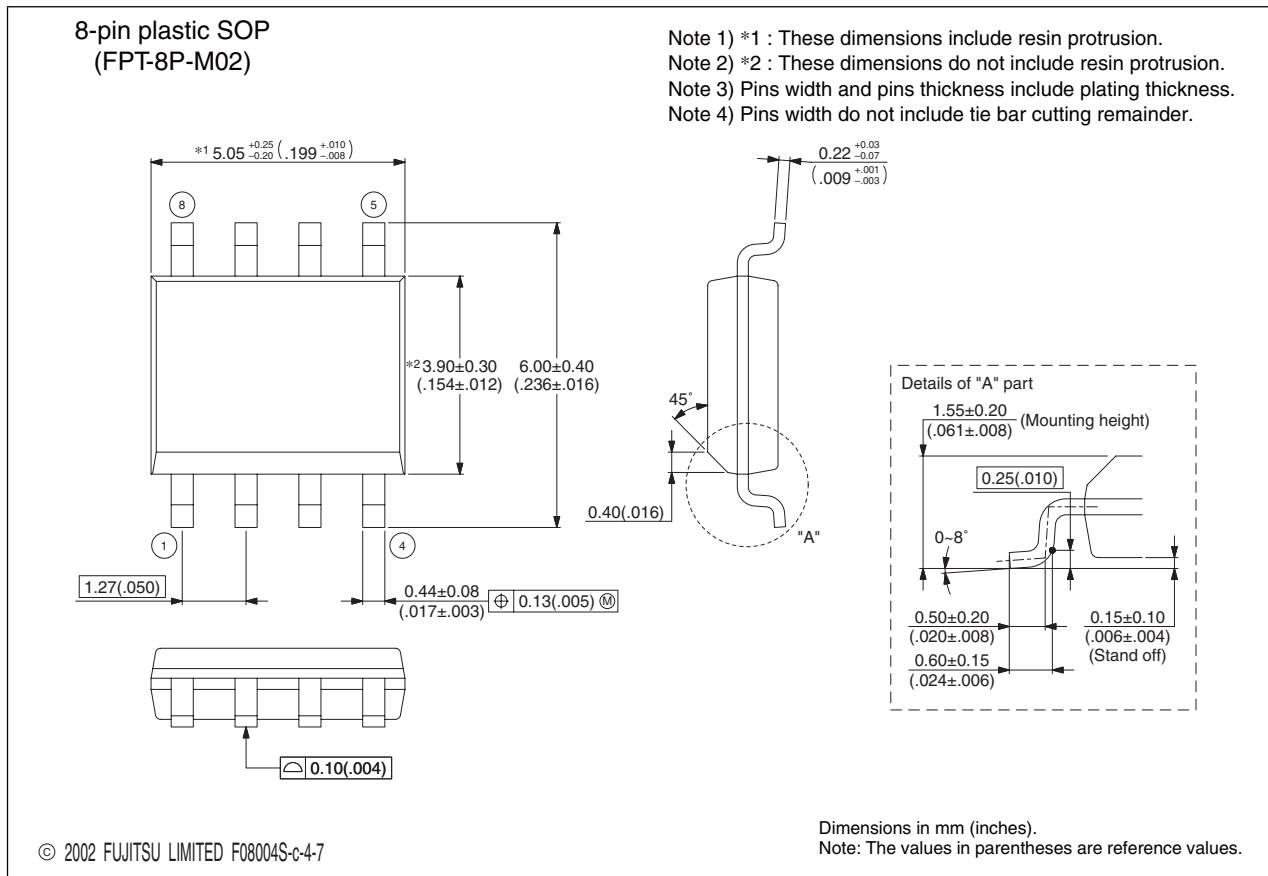
# MB88152A

## ■ ORDERING INFORMATION

| Part number               | Input/Output Frequency | Modulation type | Modulation enable pin | Package                           | Remarks                    |
|---------------------------|------------------------|-----------------|-----------------------|-----------------------------------|----------------------------|
| MB88152APNF-G-100-JNE1    | 16.6 MHz to 134 MHz    | Down spread     | No                    | 8-pin plastic SOP<br>(FPT-8P-M02) |                            |
| MB88152APNF-G-101-JNE1    | 16.6 MHz to 67 MHz     | Down spread     | Yes                   |                                   |                            |
| MB88152APNF-G-102-JNE1    | 40 MHz to 134 MHz      | Down spread     | Yes                   |                                   |                            |
| MB88152APNF-G-110-JNE1    | 16.6 MHz to 134 MHz    | Center spread   | No                    |                                   |                            |
| MB88152APNF-G-111-JNE1    | 16.6 MHz to 67 MHz     | Center spread   | Yes                   |                                   |                            |
| MB88152APNF-G-112-JNE1    | 40 MHz to 134 MHz      | Center spread   | Yes                   |                                   |                            |
| MB88152APNF-G-100-JN-EFE1 | 16.6 MHz to 134 MHz    | Down spread     | No                    | 8-pin plastic SOP<br>(FPT-8P-M02) | Emboss taping<br>(EF type) |
| MB88152APNF-G-101-JN-EFE1 | 16.6 MHz to 67 MHz     | Down spread     | Yes                   |                                   |                            |
| MB88152APNF-G-102-JN-EFE1 | 40 MHz to 134 MHz      | Down spread     | Yes                   |                                   |                            |
| MB88152APNF-G-110-JN-EFE1 | 16.6 MHz to 134 MHz    | Center spread   | No                    |                                   |                            |
| MB88152APNF-G-111-JN-EFE1 | 16.6 MHz to 67 MHz     | Center spread   | Yes                   |                                   |                            |
| MB88152APNF-G-112-JN-EFE1 | 40 MHz to 134 MHz      | Center spread   | Yes                   |                                   |                            |
| MB88152APNF-G-100-JN-ERE1 | 16.6 MHz to 134 MHz    | Down spread     | No                    | 8-pin plastic SOP<br>(FPT-8P-M02) | Emboss taping<br>(ER type) |
| MB88152APNF-G-101-JN-ERE1 | 16.6 MHz to 67 MHz     | Down spread     | Yes                   |                                   |                            |
| MB88152APNF-G-102-JN-ERE1 | 40 MHz to 134 MHz      | Down spread     | Yes                   |                                   |                            |
| MB88152APNF-G-110-JN-ERE1 | 16.6 MHz to 134 MHz    | Center spread   | No                    |                                   |                            |
| MB88152APNF-G-111-JN-ERE1 | 16.6 MHz to 67 MHz     | Center spread   | Yes                   |                                   |                            |
| MB88152APNF-G-112-JN-ERE1 | 40 MHz to 134 MHz      | Center spread   | Yes                   |                                   |                            |

## PACKAGE DIMENSION

|  |                                |               |
|--|--------------------------------|---------------|
| <p>8-pin plastic SOP</p>  <p>(FPT-8P-M02)</p> | Lead pitch                     | 1.27 mm       |
|  | Package width × package length | 3.9 × 5.05 mm |
|  | Lead shape                     | Gullwing      |
|  | Sealing method                 | Plastic mold  |
|  | Mounting height                | 1.75 mm MAX   |
|  | Weight                         | 0.06 g        |
|  |                                |               |



Please confirm the latest Package dimension by following URL.  
<http://edevic.fujitsu.com/fj/DATASHEET/ef-ovpkiv.html>

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